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Lead-free Green

## Features

- Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 3)
- "Green" Device (Note 4)


## Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating) Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.008 grams (approximate)

SOT-23


TOP VIEW


MMBD7000HS


MMBD7000HC

Maximum Ratings $@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Value | Unit |
| :--- | :---: | :---: | :---: |
| Peak Repetitive Reverse Voltage | $V_{R R M}$ <br> $V_{R W M}$ <br> Working Peak Reverse Voltage | 100 | V |
| DC Blocking Voltage |  |  |  |

## Thermal Characteristics

| Characteristic | Symbol | Value |  |
| :--- | :---: | :---: | :---: |
| Power Dissipation (Note 1) | $\mathrm{P}_{\mathrm{D}}$ | 350 | Unit |
| Thermal Resistance Junction to Ambient Air (Note 1) | $\mathrm{R}_{\theta \mathrm{JA}}$ | 357 | mW |
| Operating and Storage Temperature Range | $\mathrm{T}_{J}, \mathrm{~T}_{\mathrm{STG}}$ | -65 to +150 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

Electrical Characteristics
$@ T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified

| Characteristic | Symbol | Min | Max | Unit | Test Condition |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Reverse Breakdown Voltage (Note 2) | $\mathrm{V}_{(\mathrm{BR}) \mathrm{R}}$ | 100 | - | V | $\mathrm{I}_{\mathrm{R}}=100 \mu \mathrm{~A}$ |
| Forward Voltage | $V_{F}$ | $\begin{aligned} & 0.55 \\ & 0.67 \\ & 0.75 \end{aligned}$ | $\begin{aligned} & 0.70 \\ & 0.82 \\ & 1.10 \\ & 1.25 \end{aligned}$ | V | $\begin{aligned} & \mathrm{IF}_{F}=1.0 \mathrm{~mA} \\ & \mathrm{IF}_{F}=10 \mathrm{~mA} \\ & \mathrm{IF}_{\mathrm{F}}=50 \mathrm{~mA} \\ & \mathrm{IF}_{\mathrm{F}}=150 \mathrm{~mA} \end{aligned}$ |
| Reverse Current (Note 2) | $I_{\text {R }}$ | - | $\begin{gathered} 1.0 \\ 3.0 \\ 100 \\ 25 \\ \hline \end{gathered}$ | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> nA | $\begin{aligned} & \mathrm{V}_{\mathrm{R}}=50 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{R}}=100 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{R}}=50 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C} \\ & \mathrm{~V}_{\mathrm{R}}=20 \mathrm{~V} \\ & \hline \end{aligned}$ |
| Total Capacitance | $\mathrm{C}_{\text {T }}$ | - | 2.0 | pF | $\mathrm{V}_{\mathrm{R}}=0, \mathrm{f}=1.0 \mathrm{MHz}$ |
| Reverse Recovery Time | trr | - | 4.0 | ns | $\begin{aligned} & \mathrm{I}_{F}=\mathrm{I}_{\mathrm{R}}=10 \mathrm{~mA}, \\ & \mathrm{Irr}=0.1 \times \mathrm{I}_{\mathrm{R}}, \mathrm{R}_{\mathrm{L}}=100 \Omega \end{aligned}$ |

Notes: 1. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
2. Short duration pulse test used to minimize self-heating effect
3. No purposefully added lead. Halogen and Antimony Free.
4. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com./products/lead_free/index.php.

MMBD7000HS /HC


Fig. 1 Power Derating Curve, Total Package


Fig. 3 Typical Reverse Characteristics, Per Element

$\mathrm{V}_{\mathrm{F}}$, INSTANTANEOUS FORWARD VOLTAGE (V)
Fig. 2 Forward Characteristics, Per Element


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

## Ordering Information (Note 5)

| Part Number | Case | Packaging |
| :---: | :---: | :---: |
| MMBD7000HS-7-F | SOT-23 | 3000/Tape \& Reel |
| MMBD7000HC-7-F | SOT-23 | 3000/Tape \& Reel |

Notes: $\quad$ 5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

## Marking Information

| Year | 2009 | 2010 |  | 2011 | 2012 |  | 2013 |  | 2014 | 2015 |  | 2016 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Code | W | X |  | Y | Z |  | A | B |  | C |  | D |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |

## Package Outline Dimensions



| SOT-23 |  |  |  |
| :---: | :---: | :---: | :---: |
| Dim | Min | Max | Typ |
| A | 0.37 | 0.51 | 0.40 |
| B | 1.20 | 1.40 | 1.30 |
| C | 2.30 | 2.50 | 2.40 |
| D | 0.89 | 1.03 | 0.915 |
| F | 0.45 | 0.60 | 0.535 |
| G | 1.78 | 2.05 | 1.83 |
| H | 2.80 | 3.00 | 2.90 |
| J | 0.013 | 0.10 | 0.05 |
| K | 0.903 | 1.10 | 1.00 |
| K1 | - | - | 0.400 |
| L | 0.45 | 0.61 | 0.55 |
| M | 0.085 | 0.18 | 0.11 |
| $\alpha$ | $0^{\circ}$ | $88^{\circ}$ | - |
| $\mathbf{L y y y y y}$ | All Dimensions in $\mathbf{~ m m}$ |  |  |

## Suggested Pad Layout



| Dimensions | Value (in mm) |
| :---: | :---: |
| $\mathbf{Z}$ | 2.9 |
| $\mathbf{X}$ | 0.8 |
| $\mathbf{Y}$ | 0.9 |
| $\mathbf{C}$ | 2.0 |
| $\mathbf{E}$ | 1.35 |

MMBD7000HS /HC

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